

## LMH6550 Differential, High Speed Op Amp

Check for Samples: [LMH6550](#)

### FEATURES

- 400 MHz –3 dB Bandwidth ( $V_{OUT} = 0.5 V_{PP}$ )
- 90 MHz 0.1 dB Bandwidth
- 3000 V/ $\mu$ s Slew Rate
- 8 ns Settling Time to 0.1%
- –92/–103 dB HD2/HD3 @ 5 MHz
- 10 ns Shutdown/Enable

### APPLICATIONS

- Differential AD Driver
- Video Over Twisted Pair
- Differential Line Driver
- Single End to Differential Converter
- High Speed Differential Signaling
- IF/RF Amplifier
- SAW Filter Buffer/Driver

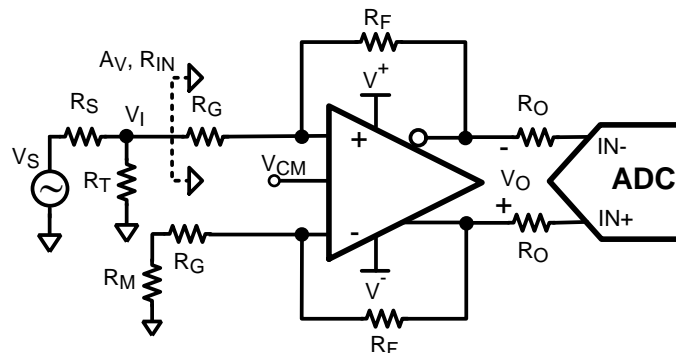
### DESCRIPTION

The LMH<sup>TM</sup>6550 is a high performance voltage feedback differential amplifier. The LMH6550 has the high speed and low distortion necessary for driving high performance ADCs as well as the current handling capability to drive signals over balanced transmission lines like CAT 5 data cables. The LMH6550 can handle a wide range of video and data formats.

With external gain set resistors, the LMH6550 can be used at any desired gain. Gain flexibility coupled with high speed makes the LMH6550 suitable for use as an IF amplifier in high performance communications equipment.

The LMH6550 is available in the space saving SOIC and VSSOP packages.

### Typical Application


For  $R_M \ll R_G$  :

$$A_v = \frac{V_O}{V_I} \cong \frac{R_F}{R_G}$$

$$R_{IN} \cong \frac{2R_G(1 + A_v)}{2 + A_v}$$

Design Target :

- 1) Set  $R_T = \frac{1}{\frac{1}{R_S} - \frac{1}{R_{IN}}}$
- 2) Set  $R_M = R_T \parallel R_S$

**Figure 1. Single Ended to Differential ADC Driver**

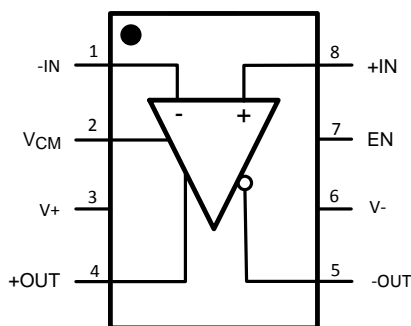


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## Connection Diagram



**Figure 2. 8-Pin SOIC & VSSOP - Top View**  
See Package Number D0008A & DGK0008A



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings <sup>(1)(2)</sup>

|   |                |
|---|----------------|
| ESD Tolerance <sup>(3)</sup>  |                |
| Human Body Model  | 2000V          |
| Machine Model   | 200V           |
| Supply Voltage  | 13.2V          |
| Common Mode Input Voltage   | $\pm V_S$      |
| Maximum Input Current (pins 1, 2, 7, 8)   | 30 mA          |
| Maximum Output Current (pins 4, 5)  | <sup>(4)</sup> |
| Maximum Junction Temperature  | 150°C          |
| Soldering Information:  |                |
| See Product Folder at <a href="http://www.ti.com">www.ti.com</a> and <a href="#">SNOA549C</a> |                |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications, see the Electrical Characteristics tables.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Human body model: 1.5 k $\Omega$  in series with 100 pF. Machine model: 0 $\Omega$  in series with 200pF.
- (4) The maximum output current ( $I_{OUT}$ ) is determined by device power dissipation limitations.

## Operating Ratings <sup>(1)</sup>

|   |                 |
|---|-----------------|
| Operating Temperature Range                                 | -40°C to +85°C  |
| Storage Temperature Range                                   | -65°C to +150°C |
| Total Supply Voltage  | 4.5V to 12V     |
| Package Thermal Resistance ( $\theta_{JA}$ ) <sup>(2)</sup> |                 |
| 8-Pin SOIC  | 150°C/W         |
| 8-Pin VSSOP   | 235°C/W         |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications, see the Electrical Characteristics tables.
- (2) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$  and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A) / \theta_{JA}$ . All numbers apply for package soldered directly into a 2 layer PC board with zero air flow.

## ±5V Electrical Characteristics <sup>(1)</sup>

Single ended in differential out,  $T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $V_{CM} = 0\text{V}$ ,  $R_F = R_G = 365\Omega$ ,  $R_L = 500\Omega$ ; Unless specified. **Boldface** limits apply at the temperature extremes.

| Symbol  | Parameter                                      | Conditions   | Min <sup>(2)</sup> | Typ <sup>(3)</sup> | Max <sup>(2)</sup> | Units                        |
|---|--|--|--------------------|--------------------|--------------------|------------------------------|
| <b>AC Performance (Differential)</b>  |  |  |                    |                    |                    |                              |
| SSBW  | Small Signal –3 dB Bandwidth                   | $V_{OUT} = 0.5 V_{PP}$                                     |                    | 400                |                    | MHz                          |
| LSBW  | Large Signal –3 dB Bandwidth                   | $V_{OUT} = 2 V_{PP}$                                       |                    | 380                |                    | MHz                          |
|   | Large Signal –3 dB Bandwidth                   | $V_{OUT} = 4 V_{PP}$                                       |                    | 320                |                    | MHz                          |
|   | 0.1 dB Bandwidth                               | $V_{OUT} = 0.5 V_{PP}$                                     |                    | 90                 |                    | MHz                          |
|   | Slew Rate                                      | 4V Step <sup>(4)</sup>                                     | 2000               | 3000               |                    | V/ $\mu\text{s}$             |
|   | Rise/Fall Time                                 | 2V Step  |                    | 1                  |                    | ns                           |
|   | Settling Time                                  | 2V Step, 0.1%  |                    | 8                  |                    | ns                           |
| <b><math>V_{CM}</math> Pin AC Performance (Common Mode Feedback Amplifier)</b>        |  |  |                    |                    |                    |                              |
|   | Common Mode Small Signal Bandwidth             | $V_{CM}$ Bypass Capacitor Removed                          |                    | 210                |                    | MHz                          |
|   | Slew Rate                                      | $V_{CM}$ Bypass Capacitor Removed                          |                    | 200                |                    | V/ $\mu\text{s}$             |
| <b>Distortion and Noise Response</b>  |  |  |                    |                    |                    |                              |
| HD2   | 2 <sup>nd</sup> Harmonic Distortion            | $V_O = 2 V_{PP}$ , $f = 5\text{ MHz}$ , $R_L = 800\Omega$  |                    | –92                |                    | dBc                          |
|   |  | $V_O = 2 V_{PP}$ , $f = 20\text{ MHz}$ , $R_L = 800\Omega$ |                    | –78                |                    |                              |
|   |  | $V_O = 2 V_{PP}$ , $f = 70\text{ MHz}$ , $R_L = 800\Omega$ |                    | –59                |                    |                              |
| HD3   | 3 <sup>rd</sup> Harmonic Distortion            | $V_O = 2 V_{PP}$ , $f = 5\text{ MHz}$ , $R_L = 800\Omega$  |                    | –103               |                    | dBc                          |
|   |  | $V_O = 2 V_{PP}$ , $f = 20\text{ MHz}$ , $R_L = 800\Omega$ |                    | –88                |                    |                              |
|   |  | $V_O = 2 V_{PP}$ , $f = 70\text{ MHz}$ , $R_L = 800\Omega$ |                    | –50                |                    |                              |
| $e_n$   | Input Referred Voltage Noise                   | $f \geq 1\text{ MHz}$                                      |                    | 6.0                |                    | nV/ $\sqrt{\text{Hz}}$       |
| $i_n$   | Input Referred Noise Current                   | $f \geq 1\text{ MHz}$                                      |                    | 1.5                |                    | pA/ $\sqrt{\text{Hz}}$       |
| <b>Input Characteristics (Differential)</b>   |  |  |                    |                    |                    |                              |
| $V_{OSD}$   | Input Offset Voltage                           | Differential Mode, $V_{ID} = 0$ , $V_{CM} = 0$             |                    | 1                  | $\pm 4$<br>$\pm 6$ | mV                           |
|   | Input Offset Voltage Average Temperature Drift | <sup>(5)</sup>   |                    | 1.6                |                    | $\mu\text{V}/^\circ\text{C}$ |
| $I_{BI}$  | Input Bias Current                             | <sup>(6)</sup>   | 0                  | –8                 | –16                | $\mu\text{A}$                |
|   | Input Bias Current Average Temperature Drift   | <sup>(5)</sup>   |                    | 9.6                |                    | nA/ $^\circ\text{C}$         |
|   | Input Bias Difference                          | Difference in Bias Currents Between the Two Inputs         |                    | 0.3                |                    | $\mu\text{A}$                |
| CMRR  | Common Mode Rejection Ratio                    | DC, $V_{CM} = 0\text{V}$ , $V_{ID} = 0\text{V}$            | 72                 | 82                 |                    | dBc                          |
| $R_{IN}$  | Input Resistance                               | Differential   |                    | 5                  |                    | M $\Omega$                   |
| $C_{IN}$  | Input Capacitance                              | Differential   |                    | 1                  |                    | pF                           |
| CMVR  | Input Common Mode Voltage Range                | CMRR > 53 dB   | +3.1<br>–4.6       | +3.2<br>–4.7       |                    | V                            |
| <b><math>V_{CM}</math> Pin Input Characteristics (Common Mode Feedback Amplifier)</b> |  |  |                    |                    |                    |                              |
| $V_{OSC}$   | Input Offset Voltage                           | Common Mode, $V_{ID} = 0$                                  |                    | 1                  | $\pm 5$<br>$\pm 8$ | mV                           |
|   | Input Offset Voltage Average Temperature Drift | <sup>(5)</sup>   |                    | 25                 |                    | $\mu\text{V}/^\circ\text{C}$ |
|   | Input Bias Current                             | <sup>(6)</sup>   |                    | –2                 |                    | $\mu\text{A}$                |

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ .
- (2) Limits are 100% production tested at  $25^\circ\text{C}$ . Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control (SQC) methods.
- (3) Typical numbers are the most likely parametric norm.
- (4) Slew Rate is the average of the rising and falling edges.
- (5) Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.
- (6) Negative input current implies current flowing out of the device.

## ±5V Electrical Characteristics <sup>(1)</sup> (continued)

Single ended in differential out,  $T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $V_{CM} = 0\text{V}$ ,  $R_F = R_G = 365\Omega$ ,  $R_L = 500\Omega$ ; Unless specified. **Boldface** limits apply at the temperature extremes.

| Symbol                           | Parameter                        | Conditions  | Min <sup>(2)</sup>  | Typ <sup>(3)</sup> | Max <sup>(2)</sup> | Units         |
|----------------------------------|----------------------------------|---|---------------------|--------------------|--------------------|---------------|
|                                  | $V_{CM}$ CMRR                    | $V_{ID} = 0\text{V}$ , 1V Step on $V_{CM}$ Pin, Measure $V_{OD}$  | 70                  | 75                 |                    | dB            |
|                                  | Input Resistance                 |   |                     | 25                 |                    | k $\Omega$    |
|                                  | Common Mode Gain                 | $\Delta V_{O,CM}/\Delta V_{CM}$   | 0.995               | 0.997              | 1.005              | V/V           |
| <b>Output Performance</b>        |                                  |   |                     |                    |                    |               |
|                                  | Output Voltage Swing             | Peak to Peak, Differential  | 7.38<br><b>7.18</b> | 7.8                |                    | V             |
|                                  | Output Common Mode Voltage Range | $V_{ID} = 0\text{V}$ ,  | $\pm 3.69$          | $\pm 3.8$          |                    | V             |
| $I_{OUT}$                        | Linear Output Current            | $V_{OUT} = 0\text{V}$   | $\pm 63$            | $\pm 75$           |                    | mA            |
| $I_{SC}$                         | Short Circuit Current            | Output Shorted to Ground<br>$V_{IN} = 3\text{V}$ Single Ended <sup>(7)</sup>  |                     | $\pm 200$          |                    | mA            |
|                                  | Output Balance Error             | $\Delta V_{OUT}$ Common Mode / $\Delta V_{OUT}$ Differential, $V_{OUT} = 1\text{V}_{PP}$ Differential, $f = 10\text{MHz}$ |                     | -68                |                    | dB            |
| <b>Miscellaneous Performance</b> |                                  |   |                     |                    |                    |               |
|                                  | Enable Voltage Threshold         | Pin 7   | 2.0                 |                    |                    | V             |
|                                  | Disable Voltage Threshold        | Pin 7   |                     |                    | 1.5                | V             |
|                                  | Enable Pin Current               | $V_{EN} = 0\text{V}$ <sup>(8)</sup>   |                     | -250               |                    | $\mu\text{A}$ |
|                                  |                                  | $V_{EN} = 4\text{V}$ <sup>(8)</sup>   |                     | 55                 |                    |               |
|                                  | Enable/Disable Time              |   |                     | 10                 |                    | ns            |
| $A_{VOL}$                        | Open Loop Gain                   | Differential  |                     | 70                 |                    | dB            |
| PSRR                             | Power Supply Rejection Ratio     | DC, $\Delta V_S = \pm 1\text{V}$  | 74                  | 90                 |                    | dB            |
|                                  | Supply Current                   | $R_L = \infty$  | 18                  | 20                 | 24<br><b>27</b>    | mA            |
|                                  | Disabled Supply Current          |   |                     | 1                  | 1.2                | mA            |

(7) The maximum output current ( $I_{OUT}$ ) is determined by device power dissipation limitations.

(8) Negative input current implies current flowing out of the device.

## 5V Electrical Characteristics <sup>(1)</sup>

Single ended in differential out,  $T_A = 25^\circ\text{C}$ ,  $A_V = +1$ ,  $V_S = 5\text{V}$ ,  $V_{CM} = 2.5\text{V}$ ,  $R_F = R_G = 365\Omega$ ,  $R_L = 500\Omega$ ; Unless specified.

**Boldface** limits apply at the temperature extremes.

| Symbol   | Parameter                          | Conditions                                       | Min <sup>(2)</sup> | Typ <sup>(3)</sup> | Max <sup>(2)</sup> | Units            |
|--|------------------------------------|--|--------------------|--------------------|--------------------|------------------|
| SSBW   | Small Signal -3 dB Bandwidth       | $R_L = 500\Omega$ , $V_{OUT} = 0.5\text{V}_{PP}$ |                    | 350                |                    | MHz              |
| LSBW   | Large Signal -3 dB Bandwidth       | $R_L = 500\Omega$ , $V_{OUT} = 2\text{V}_{PP}$   |                    | 330                |                    | MHz              |
|  | 0.1 dB Bandwidth                   |  |                    | 60                 |                    | MHz              |
|  | Slew Rate                          | 2V Step <sup>(4)</sup>                           |                    | 1500               |                    | V/ $\mu\text{s}$ |
|  | Rise/Fall Time, 10% to 90%         | 1V Step  |                    | 1                  |                    | ns               |
|  | Settling Time                      | 1V Step, 0.05%                                   |                    | 12                 |                    | ns               |
| <b><math>V_{CM}</math> Pin AC Performance (Common Mode Feedback Amplifier)</b> |                                    |  |                    |                    |                    |                  |
|  | Common Mode Small Signal Bandwidth |  |                    | 185                |                    | MHz              |
|  | Slew Rate                          |  |                    | 180                |                    | V/ $\mu\text{s}$ |

(1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ .

(2) Limits are 100% production tested at  $25^\circ\text{C}$ . Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control (SQC) methods.

(3) Typical numbers are the most likely parametric norm.

(4) Slew Rate is the average of the rising and falling edges.

## 5V Electrical Characteristics <sup>(1)</sup> (continued)

Single ended in differential out,  $T_A = 25^\circ\text{C}$ ,  $A_V = +1$ ,  $V_S = 5\text{V}$ ,  $V_{CM} = 2.5\text{V}$ ,  $R_F = R_G = 365\Omega$ ,  $R_L = 500\Omega$ ; Unless specified.

**Boldface** limits apply at the temperature extremes.

| Symbol  | Parameter                                      | Conditions   | Min <sup>(2)</sup> | Typ <sup>(3)</sup> | Max <sup>(2)</sup> | Units                        |
|---|--|--|--------------------|--------------------|--------------------|------------------------------|
| <b>Distortion and Noise Response</b>  |  |  |                    |                    |                    |                              |
| HD2   | 2 <sup>nd</sup> Harmonic Distortion            | $V_O = 2 V_{PP}$ , $f = 5\text{ MHz}$ , $R_L = 800\Omega$  |                    | -89                |                    | dBc                          |
|   |  | $V_O = 2 V_{PP}$ , $f = 20\text{ MHz}$ , $R_L = 800\Omega$   |                    | -88                |                    |                              |
| HD3   | 3 <sup>rd</sup> Harmonic Distortion            | $V_O = 2 V_{PP}$ , $f = 5\text{ MHz}$ , $R_L = 800\Omega$  |                    | -85                |                    | dBc                          |
|   |  | $V_O = 2 V_{PP}$ , $f = 20\text{ MHz}$ , $R_L = 800\Omega$   |                    | -70                |                    |                              |
| $e_n$   | Input Referred Noise Voltage                   | $f \geq 1\text{ MHz}$  |                    | 6.0                |                    | $\text{nV}/\sqrt{\text{Hz}}$ |
| $i_n$   | Input Referred Noise Current                   | $f \geq 1\text{ MHz}$  |                    | 1.5                |                    | $\text{pA}/\sqrt{\text{Hz}}$ |
| <b>Input Characteristics (Differential)</b>   |  |  |                    |                    |                    |                              |
| $V_{OSD}$   | Input Offset Voltage                           | Differential Mode, $V_{ID} = 0$ , $V_{CM} = 0$   |                    | 1                  | $\pm 4$<br>$\pm 6$ | mV                           |
|   | Input Offset Voltage Average Temperature Drift | <sup>(5)</sup>   |                    | 1.6                |                    | $\mu\text{V}/^\circ\text{C}$ |
| $I_{BIAS}$  | Input Bias Current                             | <sup>(6)</sup>   | 0                  | -8                 | -16                | $\mu\text{A}$                |
|   | Input Bias Current Average Temperature Drift   | <sup>(5)</sup>   |                    | 9.5                |                    | $\text{nA}/^\circ\text{C}$   |
|   | Input Bias Current Difference                  | Difference in Bias Currents Between the Two Inputs   |                    | 0.3                |                    | $\mu\text{A}$                |
| CMRR  | Common-Mode Rejection Ratio                    | DC, $V_{ID} = 0\text{V}$   | 70                 | 80                 |                    | dBc                          |
|   | Input Resistance                               | Differential   |                    | 5                  |                    | $\text{M}\Omega$             |
|   | Input Capacitance                              | Differential   |                    | 1                  |                    | pF                           |
| $V_{ICM}$   | Input Common Mode Range                        | CMRR > 53 dB   | +3.1<br>+0.4       | +3.2<br>+0.3       |                    |                              |
| <b><math>V_{CM}</math> Pin Input Characteristics (Common Mode Feedback Amplifier)</b> |  |  |                    |                    |                    |                              |
|   | Input Offset Voltage                           | Common Mode, $V_{ID} = 0$  |                    | 1                  | $\pm 5$<br>$\pm 8$ | mV                           |
|   | Input Offset Voltage Average Temperature Drift |  |                    | 18.6               |                    | $\mu\text{V}/^\circ\text{C}$ |
|   | Input Bias Current                             |  |                    | 3                  |                    | $\mu\text{A}$                |
|   | $V_{CM}$ CMRR                                  | $V_{ID} = 0$ ,<br>1V Step on $V_{CM}$ Pin, Measure $V_{OD}$  | 70                 | 75                 |                    | dB                           |
|   | Input Resistance                               | $V_{CM}$ Pin to Ground   |                    | 25                 |                    | k $\Omega$                   |
|   | Common Mode Gain                               | $\Delta V_{O,CM}/\Delta V_{CM}$  |                    | 0.991              |                    | V/V                          |
| <b>Output Performance</b>   |  |  |                    |                    |                    |                              |
| $V_{OUT}$   | Output Voltage Swing                           | Peak to Peak, Differential,<br>$V_S = \pm 2.5\text{V}$ , $V_{CM} = 0\text{V}$  | 2.4                | 2.8                |                    | V                            |
| $I_{OUT}$   | Linear Output Current                          | $V_{OUT} = 0\text{V}$ Differential   | $\pm 54$           | $\pm 70$           |                    | mA                           |
| $I_{SC}$  | Output Short Circuit Current                   | Output Shorted to Ground<br>$V_{IN} = 3\text{V}$ Single Ended <sup>(7)</sup>   |                    | 250                |                    | mA                           |
| CMVR  | Common Mode Voltage Range                      | $V_{ID} = 0$ , $V_{CM}$ Pin = 1.2V and 3.8V  | 3.72<br>1.23       | 3.8<br>1.2         |                    | V                            |
|   | Output Balance Error                           | $\Delta V_{OUT}$ Common Mode / $\Delta V_{OUT}$ Differential, $V_{OUT} = 1 V_{PP}$ Differential, $f = 10\text{ MHz}$ |                    | -65                |                    | dB                           |
| <b>Miscellaneous Performance</b>  |  |  |                    |                    |                    |                              |
|   | Enable Voltage Threshold                       | Pin 7  | 2.0                |                    |                    | V                            |
|   | Disable Voltage Threshold                      | Pin 7  |                    |                    | 1.5                | V                            |

(5) Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.

(6) Negative input current implies current flowing out of the device.

(7) The maximum output current ( $I_{OUT}$ ) is determined by device power dissipation limitations.

## 5V Electrical Characteristics <sup>(1)</sup> (continued)

Single ended in differential out,  $T_A = 25^\circ\text{C}$ ,  $A_V = +1$ ,  $V_S = 5\text{V}$ ,  $V_{CM} = 2.5\text{V}$ ,  $R_F = R_G = 365\Omega$ ,  $R_L = 500\Omega$ ; Unless specified.

**Boldface** limits apply at the temperature extremes.

| Symbol   | Parameter                    | Conditions                          | Min <sup>(2)</sup> | Typ <sup>(3)</sup> | Max <sup>(2)</sup>  | Units         |
|----------|------------------------------|-------------------------------------|--------------------|--------------------|---------------------|---------------|
|          | Enable Pin Current           | $V_{EN} = 0\text{V}$ <sup>(8)</sup> |                    | -250               |                     | $\mu\text{A}$ |
|          |                              | $V_{EN} = 4\text{V}$ <sup>(8)</sup> |                    | 55                 |                     |               |
|          | Enable/Disable Time          |                                     |                    | 10                 |                     | ns            |
|          | Open Loop Gain               | DC, Differential                    |                    | 70                 |                     | dB            |
| PSRR     | Power Supply Rejection Ratio | DC, $\Delta V_S = \pm 0.5\text{V}$  | 72                 | 77                 |                     | dB            |
| $I_S$    | Supply Current               | $R_L = \infty$                      | 16.5               | 19                 | 23.5<br><b>26.5</b> | mA            |
| $I_{SD}$ | Disabled Supply Current      |                                     |                    | 1                  | 1.2                 | mA            |

(8) Negative input current implies current flowing out of the device.

## Typical Performance Characteristics

( $T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 500\Omega$ ,  $R_F = R_G = 365\Omega$ ; Unless Specified).

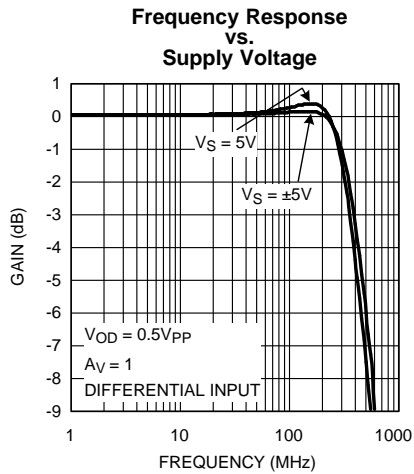


Figure 3.

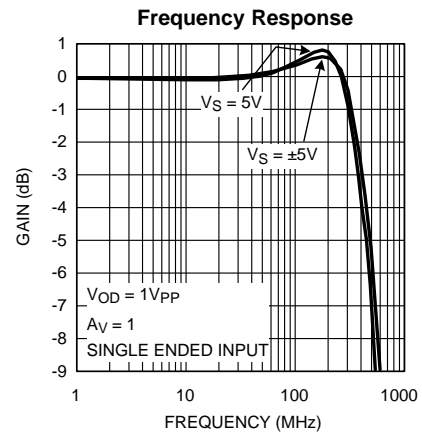


Figure 4.

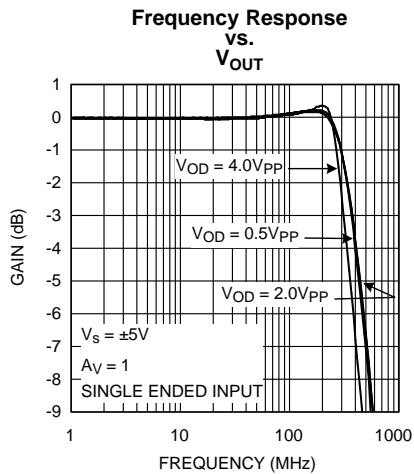


Figure 5.

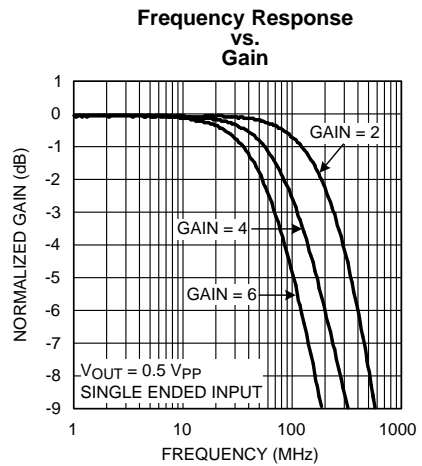


Figure 6.

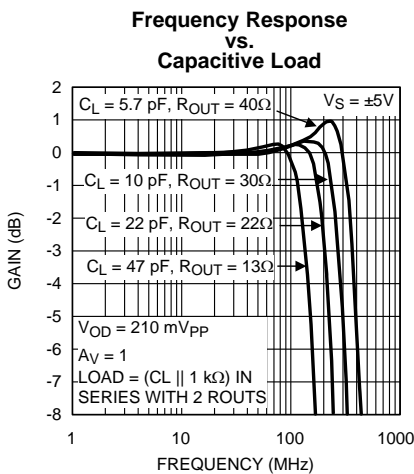


Figure 7.

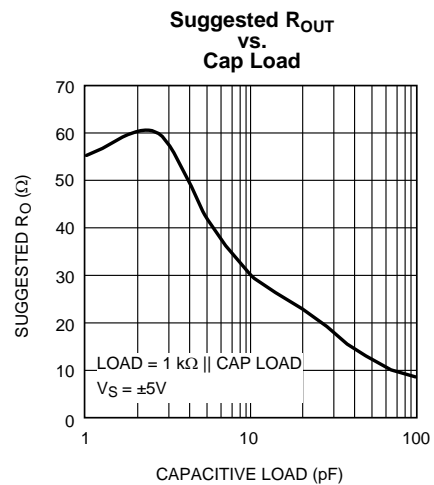


Figure 8.

## Typical Performance Characteristics (continued)

( $T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 500\Omega$ ,  $R_F = R_G = 365\Omega$ ; Unless Specified).

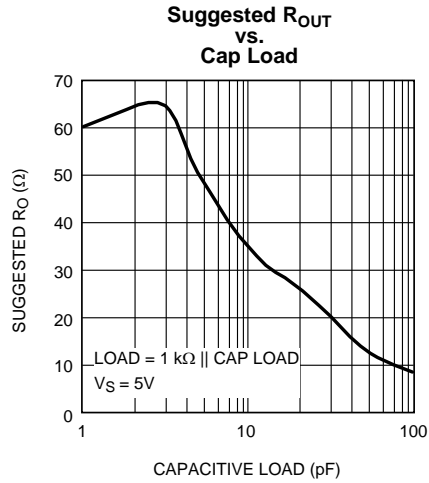


Figure 9.

### 1 $V_{PP}$ Pulse Response Single Ended Input

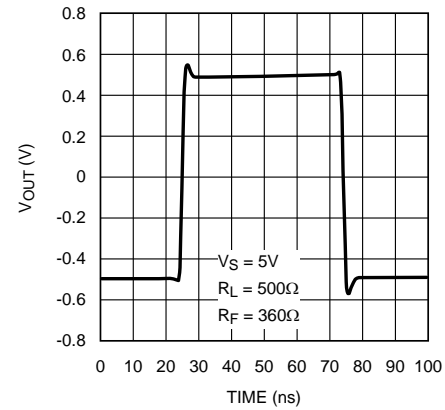


Figure 10.

### 2 $V_{PP}$ Pulse Response Single Ended Input

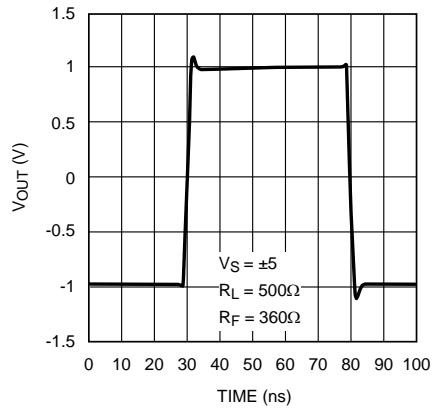


Figure 11.

### Large Signal Pulse Response

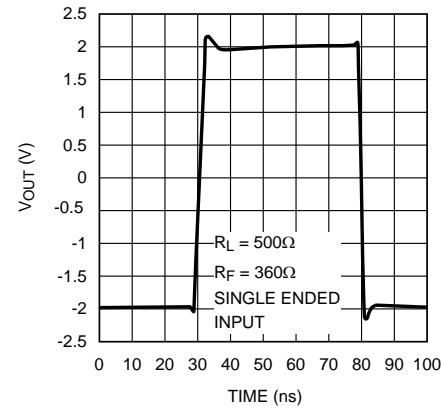


Figure 12.

### Output Common Mode Pulse Response

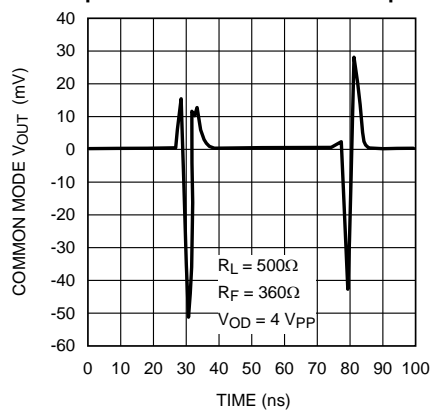


Figure 13.

### Distortion vs. Frequency Single Ended Input

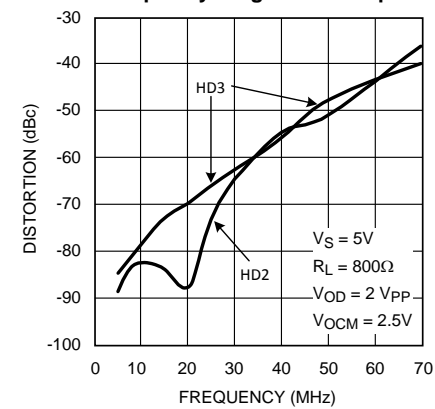


Figure 14.



## Typical Performance Characteristics (continued)

( $T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 500\Omega$ ,  $R_F = R_G = 365\Omega$ ; Unless Specified).

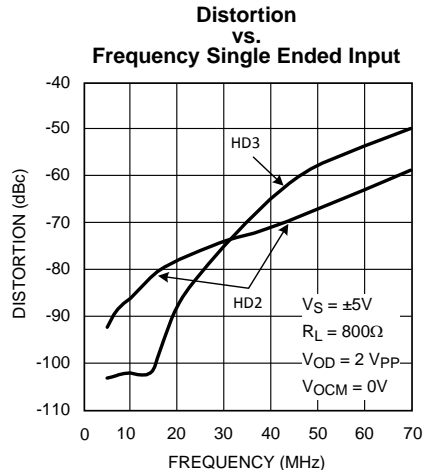


Figure 15.

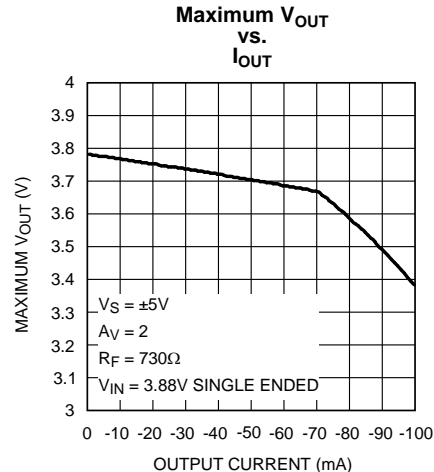


Figure 16.

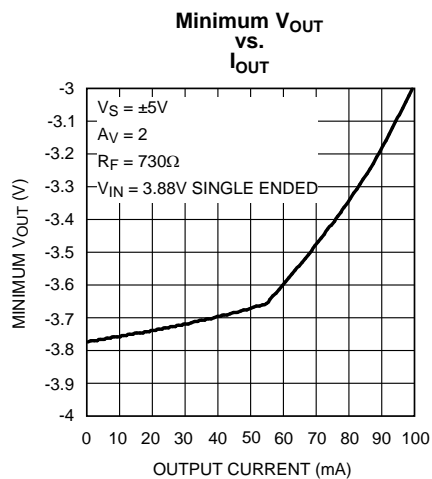


Figure 17.

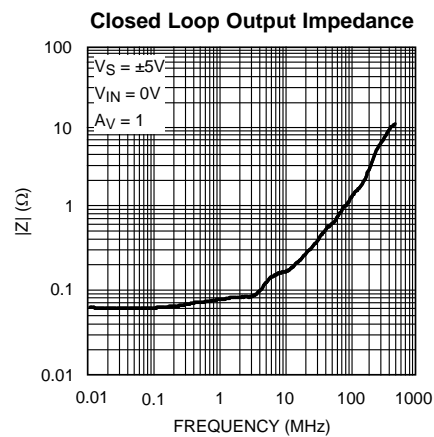


Figure 18.

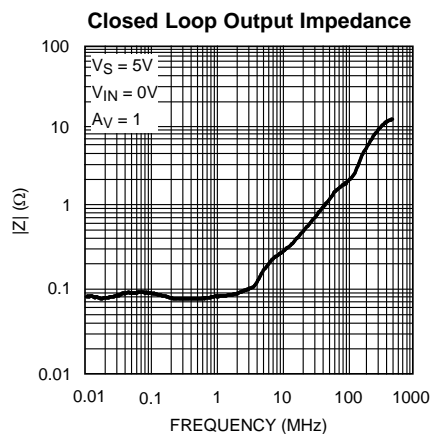


Figure 19.

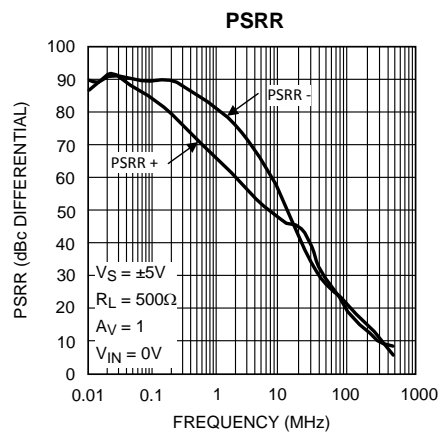


Figure 20.

### Typical Performance Characteristics (continued)

( $T_A = 25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ ,  $R_L = 500\Omega$ ,  $R_F = R_G = 365\Omega$ ; Unless Specified).

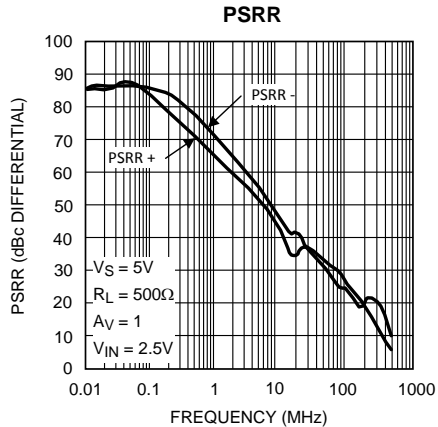


Figure 21.

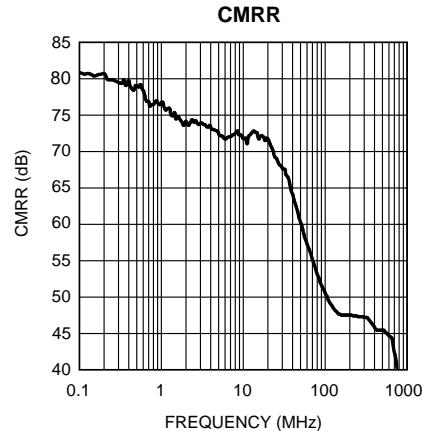


Figure 22.

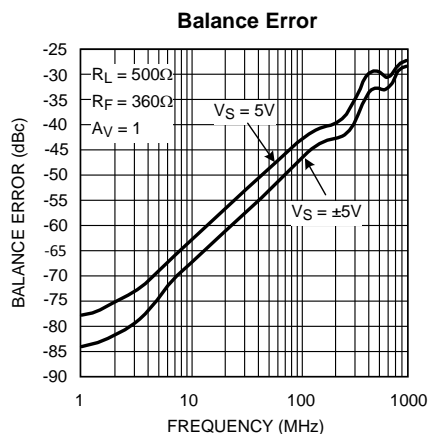


Figure 23.

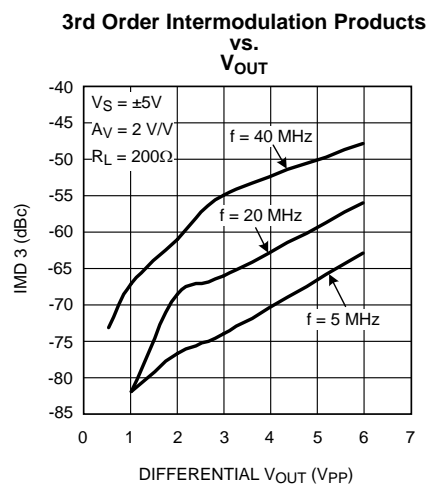


Figure 24.

## APPLICATION SECTION

The LMH6550 is a fully differential amplifier designed to provide low distortion amplification to wide bandwidth differential signals. The LMH6550, though fully integrated for ultimate balance and distortion performance, functionally provides three channels. Two of these channels are the  $V^+$  and  $V^-$  signal path channels, which function similarly to inverting mode operational amplifiers and are the primary signal paths. The third channel is the common mode feedback circuit. This is the circuit that sets the output common mode as well as driving the  $V^+$  and  $V^-$  outputs to be equal magnitude and opposite phase, even when only one of the two input channels is driven. The common mode feedback circuit allows single ended to differential operation.

The LMH6550 is a voltage feedback amplifier with gain set by external resistors. Output common mode voltage is set by the  $V_{CM}$  pin. This pin should be driven by a low impedance reference and should be bypassed to ground with a 0.1  $\mu\text{F}$  ceramic capacitor. Any signal coupling into the  $V_{CM}$  will be passed along to the output and will reduce the dynamic range of the amplifier.

The LMH6550 is equipped with an ENABLE pin to reduce power consumption when not in use. The ENABLE pin floats to logic high. If this pin is not used it can be left floating. The amplifier output stage goes into a high impedance state when the amplifier is disabled. The feedback and gain set resistors will then set the impedance of the circuit. For this reason input to output isolation will be poor in the disabled state.

### FULLY DIFFERENTIAL OPERATION

The LMH6550 will perform best when used with split supplies and in a fully differential configuration. See [Figure 25](#) and [Figure 26](#) for recommend circuits.

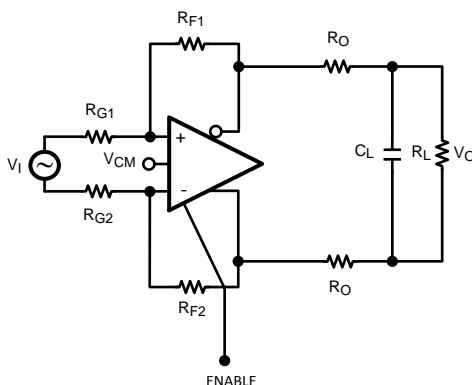


Figure 25. Typical Application

The circuit shown in [Figure 25](#) is a typical fully differential application as might be used to drive an ADC. In this circuit closed loop gain,  $(A_V) = V_{OUT}/V_{IN} = R_F/R_G$ . For all the applications in this data sheet  $V_{IN}$  is presumed to be the voltage presented to the circuit by the signal source. For differential signals this will be the difference of the signals on each input (which will be double the magnitude of each individual signal), while in single ended inputs it will just be the driven input signal.

The resistors  $R_O$  help keep the amplifier stable when presented with a load  $C_L$  as is typical in an analog to digital converter (ADC). When fed with a differential signal, the LMH6550 provides excellent distortion, balance and common mode rejection provided the resistors  $R_F$ ,  $R_G$  and  $R_O$  are well matched and strict symmetry is observed in board layout. With a DC CMRR of over 80 dB, the DC and low frequency CMRR of most circuits will be dominated by the external resistors and board trace resistance. At higher frequencies board layout symmetry becomes a factor as well. Precision resistors of at least 0.1% accuracy are recommended and careful board layout will also be required.

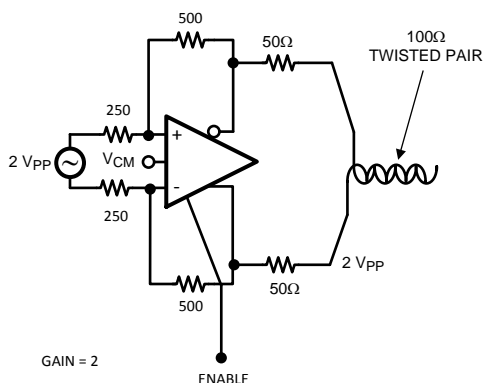


Figure 26. Fully Differential Cable Driver

With up to 15 V<sub>PP</sub> differential output voltage swing and 80 mA of linear drive current the LMH6550 makes an excellent cable driver as shown in Figure 26. The LMH6550 is also suitable for driving differential cables from a single ended source.

The LMH6550 requires supply bypassing capacitors as shown in Figure 27 and Figure 28. The 0.01 μF and 0.1 μF capacitors should be leadless SMT ceramic capacitors and should be no more than 3 mm from the supply pins. The SMT capacitors should be connected directly to a ground plane. Thin traces or small vias will reduce the effectiveness of bypass capacitors. Also shown in both figures is a capacitor from the V<sub>CM</sub> pin to ground. The V<sub>CM</sub> pin is a high impedance input to a buffer which sets the output common mode voltage. Any noise on this input is transferred directly to the output. Output common mode noise will result in loss of dynamic range, degraded CMRR, degraded Balance and higher distortion. The V<sub>CM</sub> pin should be bypassed even if the pin is not used. There is an internal resistive divider on chip to set the output common mode voltage to the mid point of the supply pins. The impedance looking into this pin is approximately 25 kΩ. If a different output common mode voltage is desired drive this pin with a clean, accurate voltage reference.

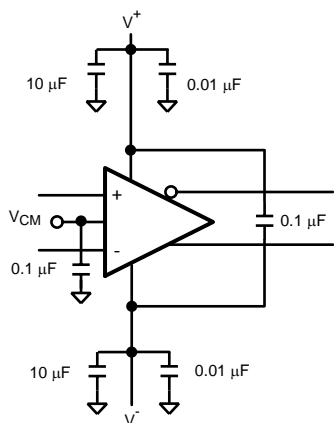


Figure 27. Split Supply Bypassing Capacitors

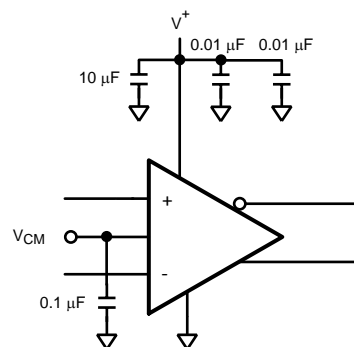


Figure 28. Single Supply Bypassing Capacitors

## SINGLE ENDED INPUT TO DIFFERENTIAL OUTPUT

The LMH6550 provides excellent performance as an active balun transformer. Figure 29 shows a typical application where an LMH6550 is used to produce a differential signal from a single ended source.

In single ended input operation the output common mode voltage is set by the  $V_{CM}$  pin as in fully differential mode. Also, in this mode the common mode feedback circuit must recreate the signal that is not present on the unused differential input pin. Figure 23 is the measurement of the effectiveness of this process. The common mode feedback circuit is responsible for ensuring balanced output with a single ended input. Balance error is defined as the amount of input signal that couples into the output common mode. It is measured as the undesired output common mode swing divided by the signal on the input. Balance error can be caused by either a channel to channel gain error, or phase error. Either condition will produce a common mode shift. Figure 23 measures the balance error with a single ended input as that is the most demanding mode of operation for the amplifier.

Supply and  $V_{CM}$  pin bypassing are also critical in this mode of operation. See the above section on for bypassing recommendations and also see Figure 27 and Figure 28 for recommended supply bypassing configurations.

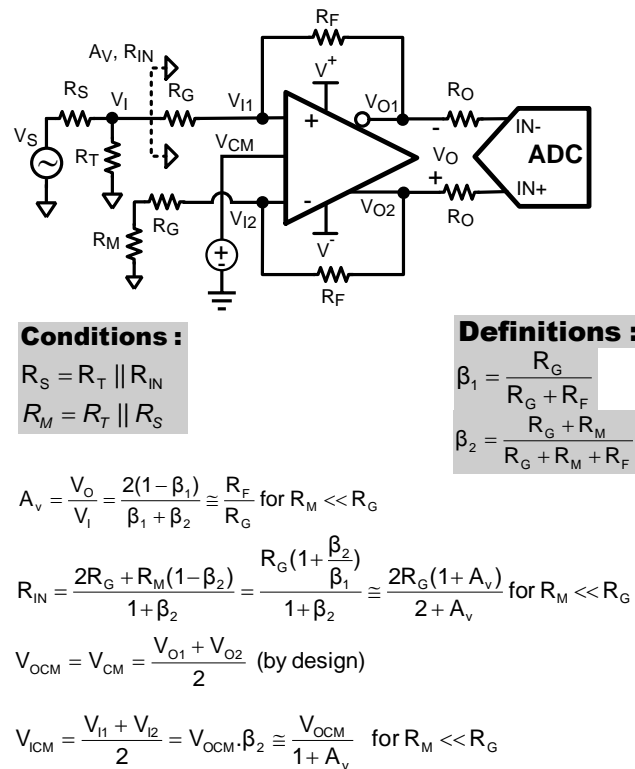


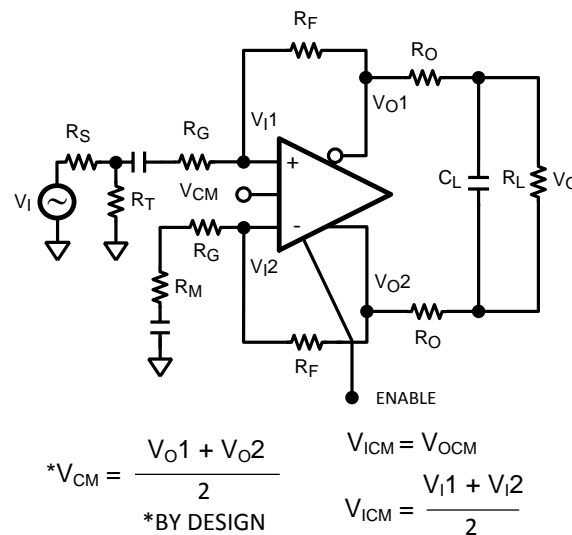
Figure 29. Single Ended In to Differential Out

## SINGLE SUPPLY OPERATION

The input stage of the LMH6550 has a built in offset of 0.7V towards the lower supply to accommodate single supply operation with single ended inputs. As shown in Figure 29, the input common mode voltage is less than the output common voltage. It is set by current flowing through the feedback network from the device output. The input common mode range of 0.4V to 3.2V places constraints on gain settings. Possible solutions to this limitation include AC coupling the input signal, using split power supplies and limiting stage gain. AC coupling with single supply is shown in Figure 30.

In Figure 29 closed loop gain  $= V_O / V_I \cong R_F / R_G$ , where  $V_I = V_S / 2$ , as long as  $R_M \ll R_G$ . Note that in single ended to differential operation  $V_I$  is measured single ended while  $V_O$  is measured differentially. This means that gain is really 1/2 or 6 dB less when measured on either of the output pins separately. Additionally, note that the input signal at  $R_T$  (labeled as  $V_I$ ) is 1/2 of  $V_S$  when  $R_T$  is chosen to match  $R_S$  to  $R_{IN}$ .

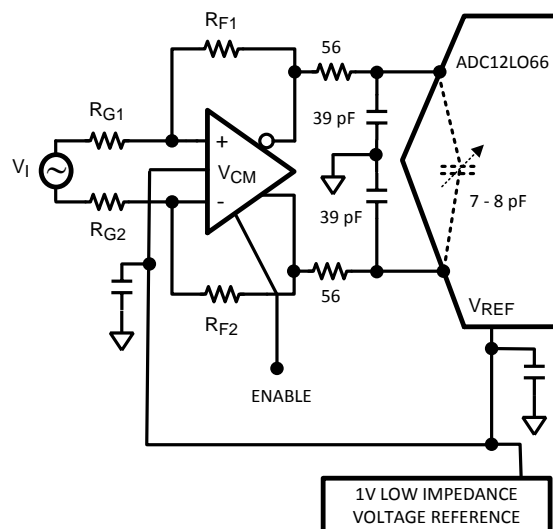
$V_{ICM}$  = Input common mode voltage =  $(V_{I1} + V_{I2}) / 2$ .



### Figure 30. AC Coupled for Single Supply Operation

## DRIVING ANALOG TO DIGITAL CONVERTERS

Analog to digital converters (ADC) present challenging load conditions. They typically have high impedance inputs with large and often variable capacitive components. As well, there are usually current spikes associated with switched capacitor or sample and hold circuits. [Figure 31](#) shows a typical circuit for driving an ADC. The two 56Ω resistors serve to isolate the capacitive loading of the ADC from the amplifier and ensure stability. In addition, the resistors form part of a low pass filter which helps to provide anti alias and noise reduction functions. The two 39 pF capacitors help to smooth the current spikes associated with the internal switching circuits of the ADC and also are a key component in the low pass filtering of the ADC input. In the circuit of [Figure 31](#) the cutoff frequency of the filter is  $1 / (2 \cdot \pi \cdot 56\Omega \cdot (39 \text{ pF} + 14 \text{ pF})) = 53 \text{ MHz}$  (which is slightly less than the sampling frequency). Note that the ADC input capacitance must be factored into the frequency response of the input filter, and that being a differential input the effective input capacitance is double. Also as shown in [Figure 31](#) the input capacitance to many ADCs is variable based on the clock cycle. See the data sheet for your particular ADC for details.



### Figure 31. Driving an ADC

The amplifier and ADC should be located as closely together as possible. Both devices require that the filter components be in close proximity to them. The amplifier needs to have minimal parasitic loading on the output traces and the ADC is sensitive to high frequency noise that may couple in on its input lines. Some high performance ADCs have an input stage that has a bandwidth of several times its sample rate. The sampling process results in all input signals presented to the input stage mixing down into the Nyquist range (DC to  $F_s/2$ ). See [AN-236](#) for more details on the subsampling process and the requirements this imposes on the filtering necessary in your system.

## USING TRANSFORMERS

Transformers are useful for impedance transformation as well as for single to differential, and differential to single ended conversion. A transformer can be used to step up the output voltage of the amplifier to drive very high impedance loads as shown in [Figure 32](#). [Figure 34](#) shows the opposite case where the output voltage is stepped down to drive a low impedance load.

Transformers have limitations that must be considered before choosing to use one. Compared to a differential amplifier, the most serious limitations of a transformer are the inability to pass DC and balance error (which causes distortion and gain errors). For most applications the LMH6550 will have adequate output swing and drive current and a transformer will not be desirable. Transformers are used primarily to interface differential circuits to 50Ω single ended test equipment to simplify diagnostic testing.

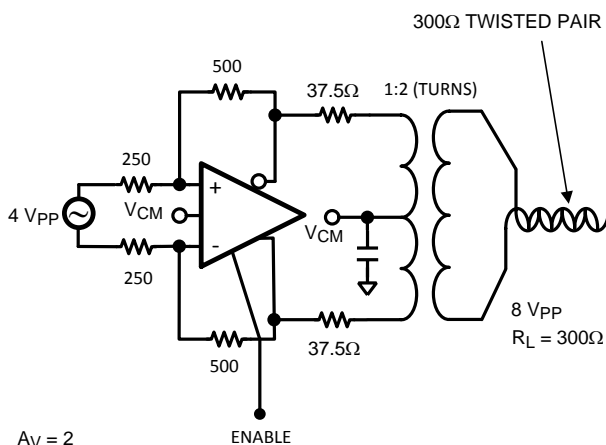


Figure 32. Transformer Out High Impedance Load

$$V_L = \frac{V_{IN} * A_V * N}{\left( \frac{2 R_{OUT} * N^2}{R_L} + 1 \right)}$$

WHERE  $V_{IN}$  = DIFFERENTIAL INPUT VOLTAGE

$$N = \text{TRANSFORMER TURNS RATIO} = \left( \frac{\text{SECONDARY}}{\text{PRIMARY}} \right)$$

$A_V$  = CLOSED LOOP AMPLIFIER GAIN

$R_{OUT}$  = SERIES OUTPUT MATCHING RESISTOR

$R_L$  = LOAD RESISTOR

$V_L$  = VOLTAGE ACROSS LOAD RESISTOR

Figure 33. Calculating Transformer Circuit Net Gain

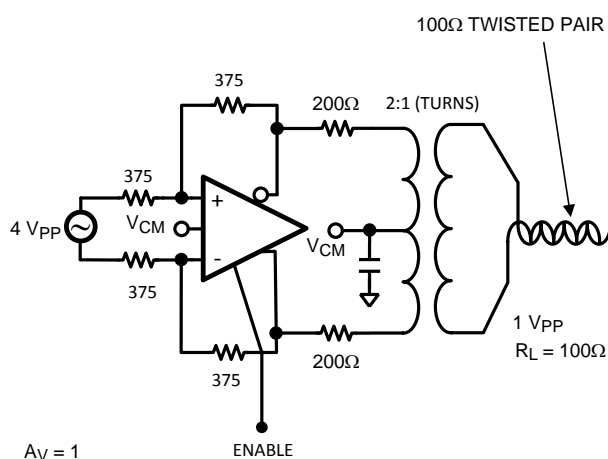


Figure 34. Transformer Out Low Impedance Load

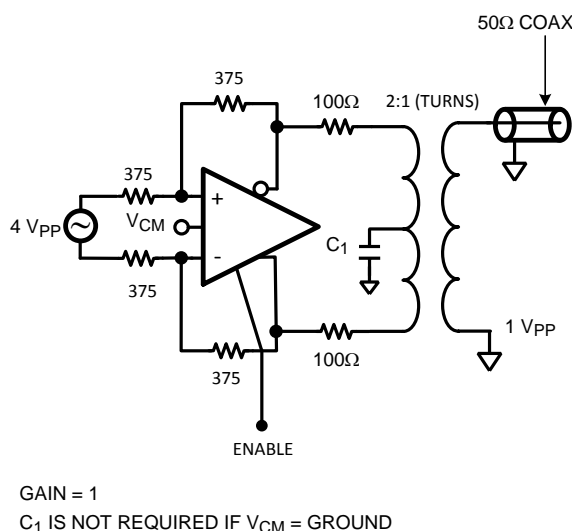


Figure 35. Driving 50Ω Test Equipment

## CAPACITIVE DRIVE

As noted in [DRIVING ANALOG TO DIGITAL CONVERTERS](#), capacitive loads should be isolated from the amplifier output with small valued resistors. This is particularly the case when the load has a resistive component that is 500Ω or higher. A typical ADC has capacitive components of around 10 pF and the resistive component could be 1000Ω or higher. If driving a transmission line, such as 50Ω coaxial or 100Ω twisted pair, using matching resistors will be sufficient to isolate any subsequent capacitance. For other applications see [Figure 8](#) and [Figure 9](#) in [Typical Performance Characteristics](#).

## POWER DISSIPATION

The LMH6550 is optimized for maximum speed and performance in the small form factor of the standard SOIC package, and is essentially a dual channel amplifier. To ensure maximum output drive and highest performance, thermal shutdown is not provided. Therefore, it is of utmost importance to make sure that the  $T_{JMAX}$  of 150°C is never exceeded due to the overall power dissipation.

Follow these steps to determine the Maximum power dissipation for the LMH6550:



1. Calculate the quiescent (no-load) power:  $P_{AMP} = I_{CC} \cdot (V_S)$ , where  $V_S = V^+ - V^-$ . (Be sure to include any current through the feedback network if  $V_{OCM}$  is not mid rail.)
2. Calculate the RMS power dissipated in each of the output stages:  $P_D (rms) = rms ((V_S - V_{OUT}^+) \cdot I_{OUT}^+) + rms ((V_S - V_{OUT}^-) \cdot I_{OUT}^-)$ , where  $V_{OUT}$  and  $I_{OUT}$  are the voltage and the current measured at the output pins of the differential amplifier as if they were single ended amplifiers and  $V_S$  is the total supply voltage.
3. Calculate the total RMS power:  $P_T = P_{AMP} + P_D$ .

The maximum power that the LMH6550 package can dissipate at a given temperature can be derived with the following equation:

$$P_{MAX} = (150^\circ - T_{AMB}) / \theta_{JA}$$

where

- $T_{AMB}$  = Ambient temperature ( $^\circ\text{C}$ )
- $\theta_{JA}$  = Thermal resistance, from junction to ambient, for a given package ( $^\circ\text{C}/\text{W}$ )
- For the SOIC package  $\theta_{JA}$  is  $150^\circ\text{C}/\text{W}$
- For the VSSOP package  $\theta_{JA}$  is  $235^\circ\text{C}/\text{W}$

(1)

#### NOTE

If  $V_{CM}$  is not 0V then there will be quiescent current flowing in the feedback network. This current should be included in the thermal calculations and added into the quiescent power dissipation of the amplifier.

## ESD PROTECTION

The LMH6550 is protected against electrostatic discharge (ESD) on all pins. The LMH6550 will survive 2000V Human Body model and 200V Machine model events. Under normal operation the ESD diodes have no effect on circuit performance. There are occasions, however, when the ESD diodes will be evident. If the LMH6550 is driven by a large signal while the device is powered down the ESD diodes will conduct. The current that flows through the ESD diodes will either exit the chip through the supply pins or will flow through the device, hence it is possible to power up a chip with a large signal applied to the input pins. Using the shutdown mode is one way to conserve power and still prevent unexpected operation.

## BOARD LAYOUT

The LMH6550 is a very high performance amplifier. In order to get maximum benefit from the differential circuit architecture board layout and component selection is very critical. The circuit board should have low a inductance ground plane and well bypassed broad supply lines. External components should be leadless surface mount types. The feedback network and output matching resistors should be composed of short traces and precision resistors (0.1%). The output matching resistors should be placed within 3-4 mm of the amplifier as should the supply bypass capacitors. The LMH730154 evaluation board is an example of good layout techniques.

The LMH6550 is sensitive to parasitic capacitances on the amplifier inputs and to a lesser extent on the outputs as well. Ground and power plane metal should be removed from beneath the amplifier and from beneath  $R_F$  and  $R_G$ .

With any differential signal path symmetry is very important. Even small amounts of asymmetry will contribute to distortion and balance errors.

## EVALUATION BOARD

National Semiconductor offers evaluation board(s) to aid in device testing and characterization and as a guide for proper layout. Generally, a good high frequency layout will keep power supply and ground traces away from the inverting input and output pins. Parasitic capacitances on these nodes to ground will cause frequency response peaking and possible circuit oscillations (see [Application Note OA-15](#) for more information).

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| LMH6550MA        | ACTIVE        | SOIC         | D                  | 8    | 95          | TBD                        | CU SNPB          | Level-1-235C-UNLIM   | -40 to 85    | LMH65<br>50MA            | <a href="#">Samples</a> |
| LMH6550MA/NOPB   | ACTIVE        | SOIC         | D                  | 8    | 95          | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM   | -40 to 85    | LMH65<br>50MA            | <a href="#">Samples</a> |
| LMH6550MAX       | ACTIVE        | SOIC         | D                  | 8    | 2500        | TBD                        | CU SNPB          | Level-1-235C-UNLIM   | -40 to 85    | LMH65<br>50MA            | <a href="#">Samples</a> |
| LMH6550MAX/NOPB  | ACTIVE        | SOIC         | D                  | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM   | -40 to 85    | LMH65<br>50MA            | <a href="#">Samples</a> |
| LMH6550MM/NOPB   | ACTIVE        | VSSOP        | DGK                | 8    | 1000        | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM   | -40 to 85    | AL1A                     | <a href="#">Samples</a> |
| LMH6550MMX       | ACTIVE        | VSSOP        | DGK                | 8    | 3500        | TBD                        | CU SNPB          | Level-1-260C-UNLIM   | -40 to 85    | AL1A                     | <a href="#">Samples</a> |
| LMH6550MMX/NOPB  | ACTIVE        | VSSOP        | DGK                | 8    | 3500        | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM   | -40 to 85    | AL1A                     | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



## NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



## NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.

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No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

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| Data Converters              | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products                | <a href="http://www.dlp.com">www.dlp.com</a>   |
| DSP                          | <a href="http://dsp.ti.com">dsp.ti.com</a>   |
| Clocks and Timers            | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>                             |
| Interface                    | <a href="http://interface.ti.com">interface.ti.com</a>                               |
| Logic                        | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt                   | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers             | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                         | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Applications Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity        | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

|                               |  |
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| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
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